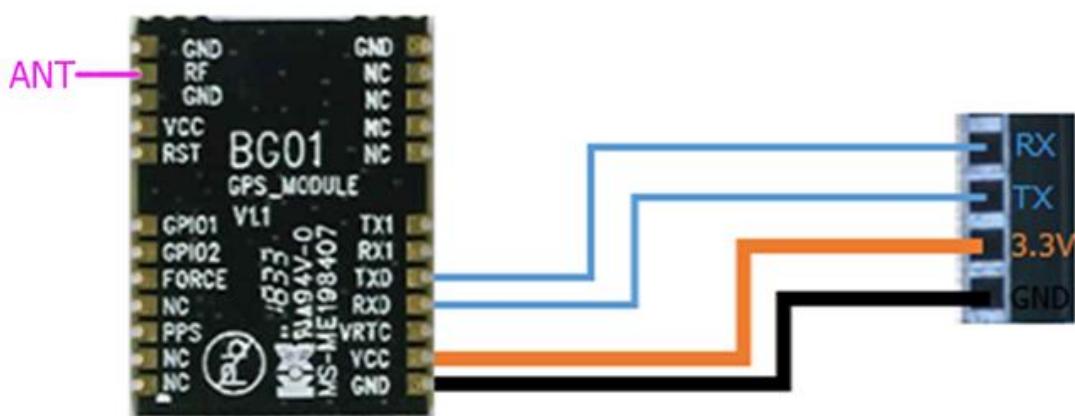


## GPS series module Hardware Guidance

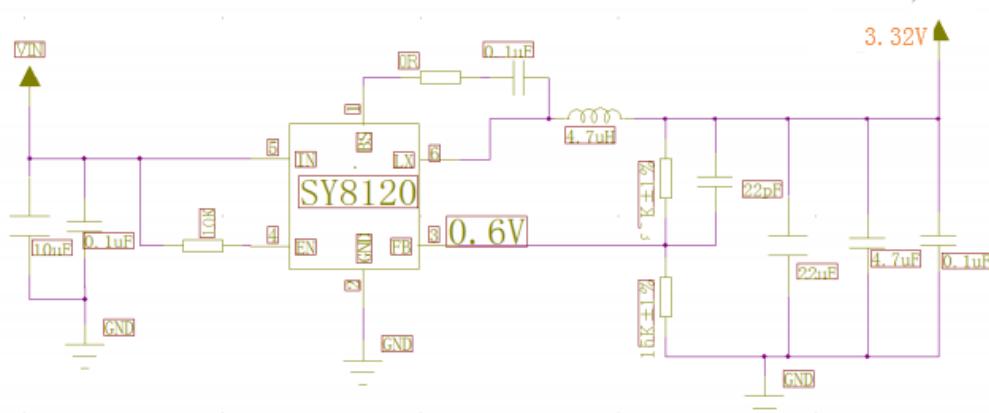
### 1. Typical application circuit

- 1.1 All of GPIOs are work at 3.3V,
- 1.2 AT command use UART0: RXD、TXD,  
band rate 9600bps



### 2. Power Supply Reference Design

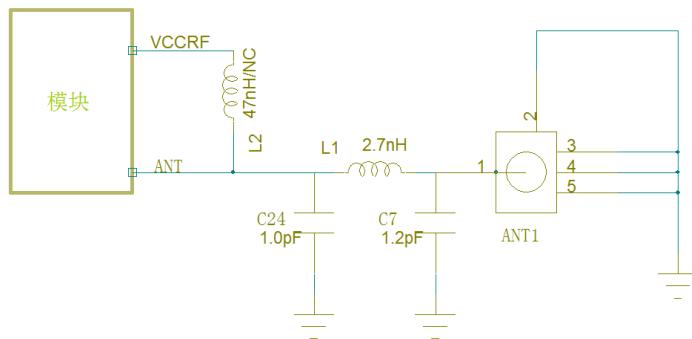
[100mA@3.3V](#) and Ripple is less than 40mV,



### 3. Module consumption such as the table

| mode        | Capture current | Tracking current |
|-------------|-----------------|------------------|
| Consumption | 30mA            | 20mA             |

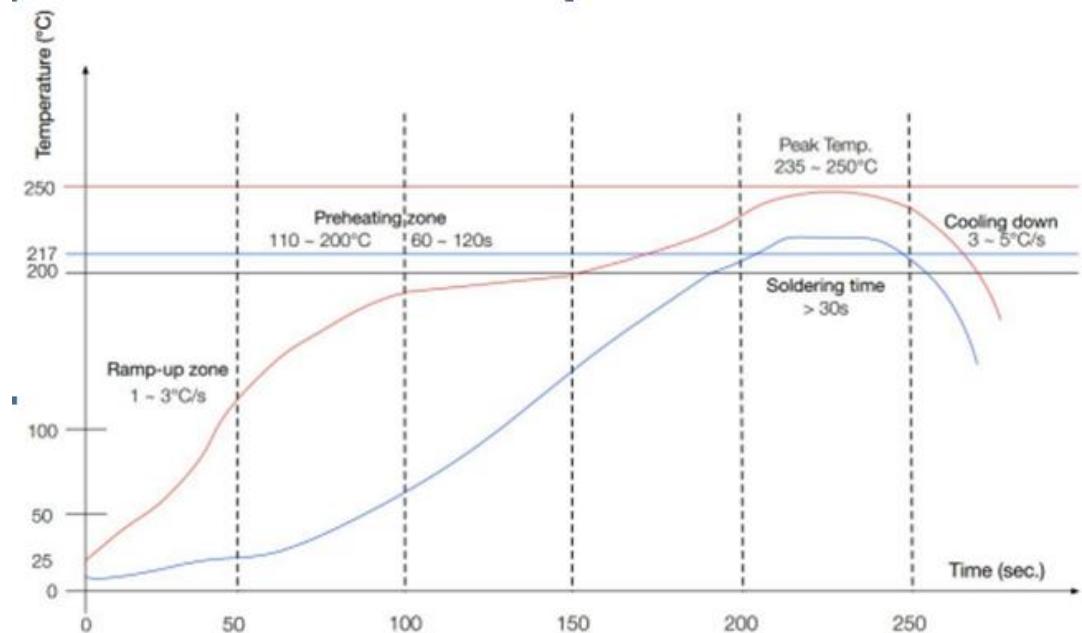
## 4. Ant circuit Reference Design



## 5. Hot Start keep circuit Reference Design



## 6. Recommend Reflow oven temperature curve



Ramp-up zone (升温区): Temp. <150°C, Time 60 ~ 90s, Ramp-up rate 1 ~ 3°C/s.

Preheating zone (预热恒温区): Temp. 150 ~ 200°C, Time 60 ~ 120s, Ramp-up rate 0.3 ~ 0.8°C/s.

Reflow soldering zone (回流焊接区): Peak Temp. 235 ~ 250°C (<245°C recommended), Time 30 ~ 70s.

Cooling down zone (冷却区): Temp. 217 ~ 170°C, Ramp-down rate 3 ~ 5°C/s.

Sn&Ag&Cu Lead-free solder (SAC305)/焊料为锡银铜合金无铅焊料